



## AON4803

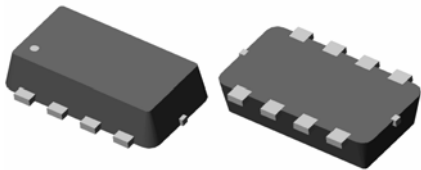
### Dual P-Channel Enhancement Mode Field Effect Transistor

#### General Description

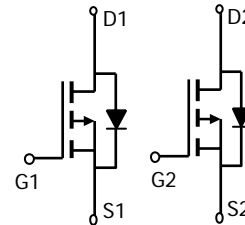
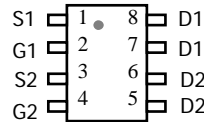
The AON4803 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltage as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. *Standard Product AON4803 is Pb-free (meets ROHS & Sony 259 specifications).*

#### Features

$V_{DS}$  (V) = -20V  
 $I_D$  = -3.4A ( $V_{GS}$  = -4.5V)  
 $R_{DS(ON)}$  < 90m $\Omega$  ( $V_{GS}$  = -4.5V)  
 $R_{DS(ON)}$  < 120m $\Omega$  ( $V_{GS}$  = -2.5V)  
 $R_{DS(ON)}$  < 165m $\Omega$  ( $V_{GS}$  = -1.8V)



DFN3X2-8L



#### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

| Parameter                              | Symbol         | MOSFET                 | Units            |
|--|----------------|------------------------|------------------|
| Drain-Source Voltage                   | $V_{DS}$       | -20                    | V                |
| Gate-Source Voltage                    | $V_{GS}$       | $\pm 8$                | V                |
| Continuous Drain Current <sup>A</sup>  | $I_D$          | $T_A=25^\circ\text{C}$ | -3.4             |
|  |                | $T_A=70^\circ\text{C}$ | -2.7             |
| Pulsed Drain Current <sup>B</sup>      | $I_{DM}$       | -15                    | A                |
| Power Dissipation                      | $P_D$          | $T_A=25^\circ\text{C}$ | 1.7              |
|  |                | $T_A=70^\circ\text{C}$ | 1.1              |
| Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 to 150             | $^\circ\text{C}$ |

| Parameter: Thermal Characteristics MOSFET | Symbol          | Typ | Max | Units              |
|---|-----------------|-----|-----|--------------------|
| Maximum Junction-to-Ambient <sup>A</sup>  | $R_{\theta JA}$ | 51  | 75  | $^\circ\text{C/W}$ |
| Maximum Junction-to-Ambient <sup>A</sup>  |                 | 88  | 110 |                    |
| Maximum Junction-to-Lead <sup>C</sup>     | $R_{\theta JL}$ | 28  | 35  |                    |

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions  | Min  | Typ   | Max       | Units            |
|-----------------------------|---------------------------------------|---|------|-------|-----------|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |   |      |       |           |                  |
| $BV_{DSS}$                  | Drain-Source Breakdown Voltage        | $I_D=-250\mu\text{A}$ , $V_{GS}=0\text{V}$  | -20  |       |           | V                |
| $I_{DSS}$                   | Zero Gate Voltage Drain Current       | $V_{DS}=-16\text{V}$ , $V_{GS}=0\text{V}$<br>$T_J=55^\circ\text{C}$                   |      |       | -1<br>-5  | $\mu\text{A}$    |
| $I_{GSS}$                   | Gate-Body leakage current             | $V_{DS}=0\text{V}$ , $V_{GS}=\pm 8\text{V}$   |      |       | $\pm 100$ | nA               |
| $V_{GS(th)}$                | Gate Threshold Voltage                | $V_{DS}=V_{GS}$ , $I_D=-250\mu\text{A}$   | -0.3 | -0.65 | -1        | V                |
| $I_{D(ON)}$                 | On state drain current                | $V_{GS}=-4.5\text{V}$ , $V_{DS}=-5\text{V}$   | -15  |       |           | A                |
| $R_{DS(ON)}$                | Static Drain-Source On-Resistance     | $V_{GS}=-4.5\text{V}$ , $I_D=-3.4\text{A}$<br>$T_J=125^\circ\text{C}$                 |      | 73    | 90        | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=-2.5\text{V}$ , $I_D=-2.5\text{A}$  |      | 103   | 125       | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=-1.8\text{V}$ , $I_D=-1.5\text{A}$  |      | 100   | 120       | $\text{m}\Omega$ |
| $g_{FS}$                    | Forward Transconductance              | $V_{DS}=-5\text{V}$ , $I_D=-3.4\text{A}$  | 4    | 7     |           | S                |
| $V_{SD}$                    | Diode Forward Voltage                 | $I_S=-1\text{A}$ , $V_{GS}=0\text{V}$   |      | -0.76 | -1        | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |   |      |       | -2        | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |   |      |       |           |                  |
| $C_{iss}$                   | Input Capacitance                     | $V_{GS}=0\text{V}$ , $V_{DS}=-10\text{V}$ , $f=1\text{MHz}$                           |      | 540   | 700       | pF               |
| $C_{oss}$                   | Output Capacitance                    |   |      | 72    |           | pF               |
| $C_{rss}$                   | Reverse Transfer Capacitance          |   |      | 49    |           | pF               |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $f=1\text{MHz}$                             |      | 12    |           | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |   |      |       |           |                  |
| $Q_g$                       | Total Gate Charge                     | $V_{GS}=-4.5\text{V}$ , $V_{DS}=-10\text{V}$ , $I_D=-3.4\text{A}$                     |      | 6.1   | 7.9       | nC               |
| $Q_{gs}$                    | Gate Source Charge                    |   |      | 0.6   |           | nC               |
| $Q_{gd}$                    | Gate Drain Charge                     |   |      | 1.6   |           | nC               |
| $t_{D(on)}$                 | Turn-On Delay Time                    | $V_{GS}=-4.5\text{V}$ , $V_{DS}=-10\text{V}$ , $R_L=2.9\Omega$ ,<br>$R_{GEN}=3\Omega$ |      | 10    |           | ns               |
| $t_r$                       | Turn-On Rise Time                     |   |      | 12    |           | ns               |
| $t_{D(off)}$                | Turn-Off Delay Time                   |   |      | 44    |           | ns               |
| $t_f$                       | Turn-Off Fall Time                    |   |      | 22    |           | ns               |
| $t_{rr}$                    | Body Diode Reverse Recovery Time      | $I_F=-3.4\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$                                  |      | 21    |           | ns               |
| $Q_{rr}$                    | Body Diode Reverse Recovery Charge    | $I_F=-3.4\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$                                  |      | 7.5   |           | nC               |

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

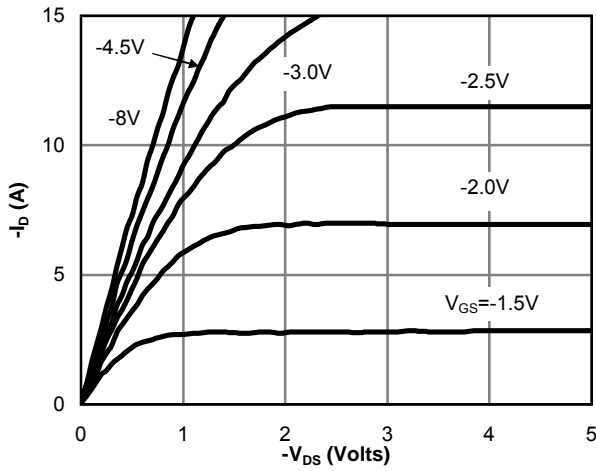
D: The static characteristics in Figures 1 to 6,12,14 are obtained using 80 $\mu\text{s}$  pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

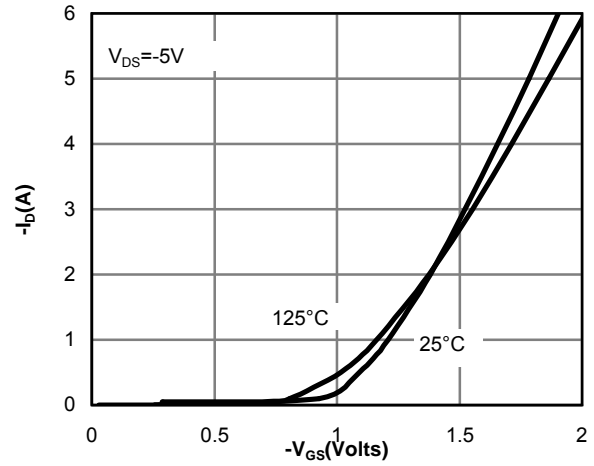
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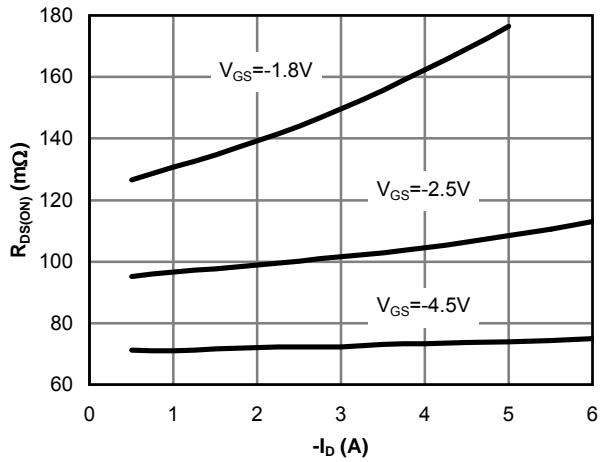
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



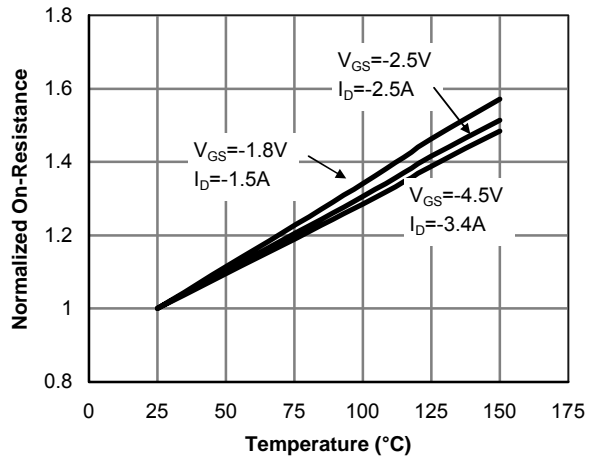
**Fig 1: On-Region Characteristics**



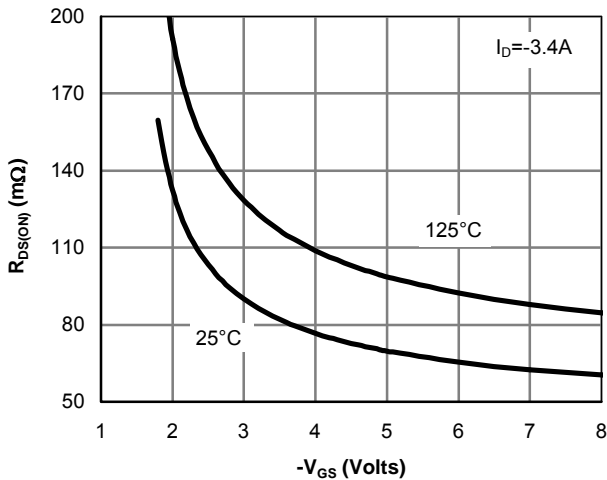
**Figure 2: Transfer Characteristics**



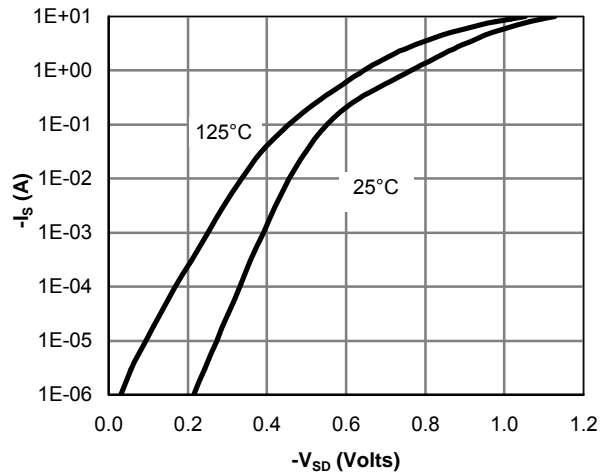
**Figure 3: On-Resistance vs. Drain Current and Gate Voltage**



**Figure 4: On-Resistance vs. Junction Temperature**



**Figure 5: On-Resistance vs. Gate-Source Voltage**



**Figure 6: Body-Diode Characteristics**

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

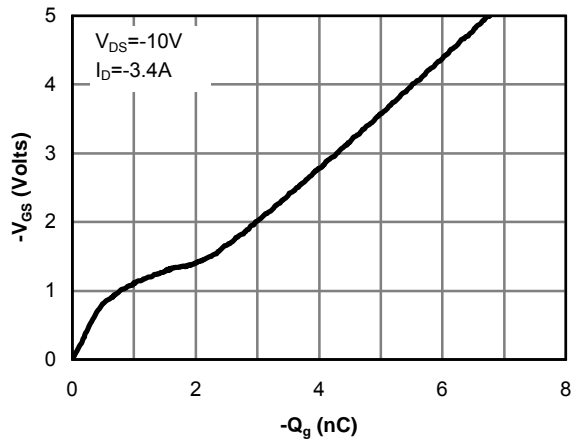


Figure 7: Gate-Charge Characteristics

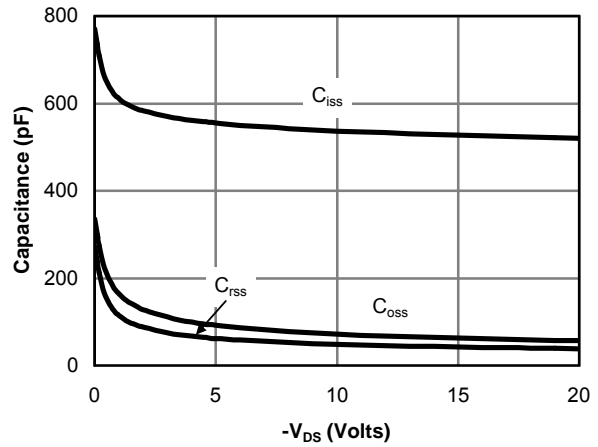


Figure 8: Capacitance Characteristics

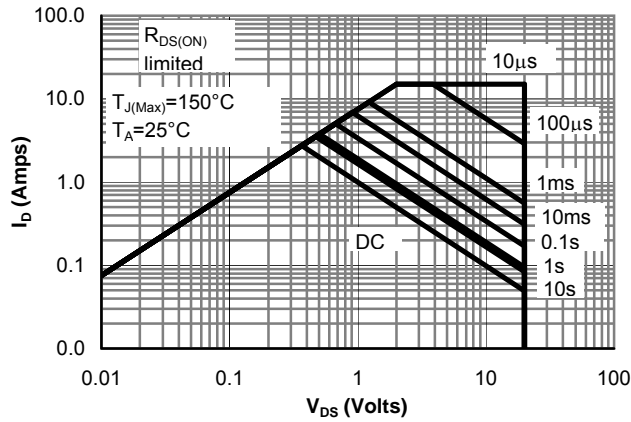


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

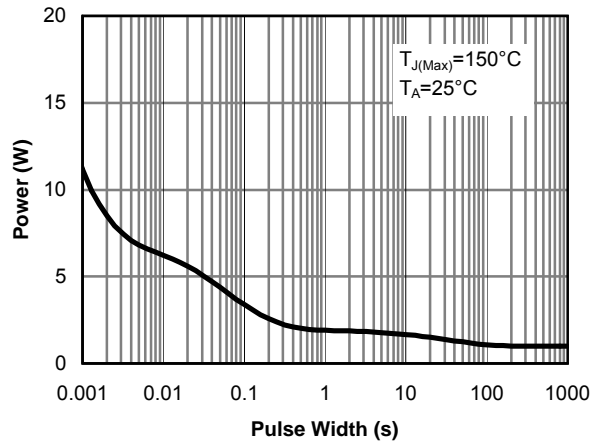


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

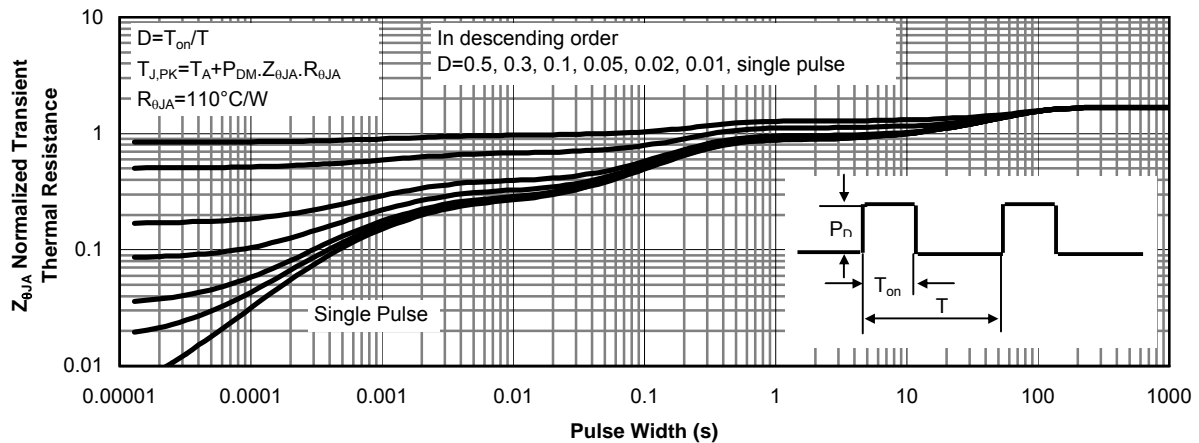


Figure 11: Normalized Maximum Transient Thermal Impedance